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# FPF1103 / FPF1104 **Advance Load Management Switch**

### Features

FAIRCHILD SEMICONDUCTOR

- 1.2V to 4V Input Voltage Operating Range
  - 55mΩ at V<sub>IN</sub>=1.8V
  - 85mΩ at V<sub>IN</sub>=1.2V
- Slew Rate Control with t<sub>R</sub>: 65µs
- Output Discharge Function on FPF1104
- Low <1µA Quiescent Current at V<sub>ON</sub>=V<sub>IN</sub>
- ESD Protected: Above 4000V HBM, 2000V CDM
- GPIO/CMOS-Compatible Enable Circuitry

#### **Applications**

- Mobile Devices and Smart Phones
- Portable Media Devices
- **Digital Cameras**
- Advanced Notebook, UMPC, MID
- Portable Medical Devices
- GPS and Navigation Equipment

### **Ordering Information**

Part Number	Part Marking	Switch (Typical) At 1.8V <sub>IN</sub>	Input Buffer	Output Discharge	ON Pin Activity	t <sub>R</sub>	Eco Status	Package
FPF1103	Q9	55mΩ	CMOS	NA	Active HIGH	65µs	Green	4-Ball, Wafer-Level Chip-
FPF1104	QA	55mΩ	CMOS	65Ω	Active HIGH	65µs	Green	Scale Package (WLCSP), 1.0 x 1.0mm, 0.5mm Pitch

Description

The FPF1103/04 are low R<sub>DS</sub> P-channel MOSFET load

switches of the IntelliMAX<sup>™</sup> family. Integrated slew-rate

control prevents inrush current from glitch supply rails with capacitive loads common in power applications.

The input voltage range operates from 1.2V to 4V to

fulfill today's lowest ultra-portable device supply requirements. Switch control is by a logic input (ON-pin)

capable of interfacing directly with low-voltage CMOS

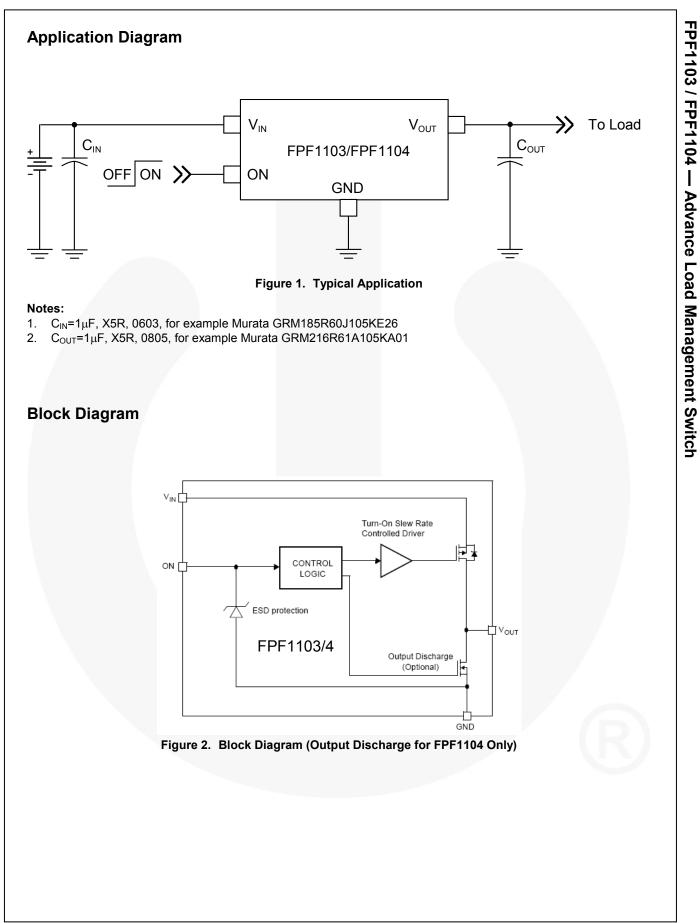
control signals and GPIOs in embedded processors.

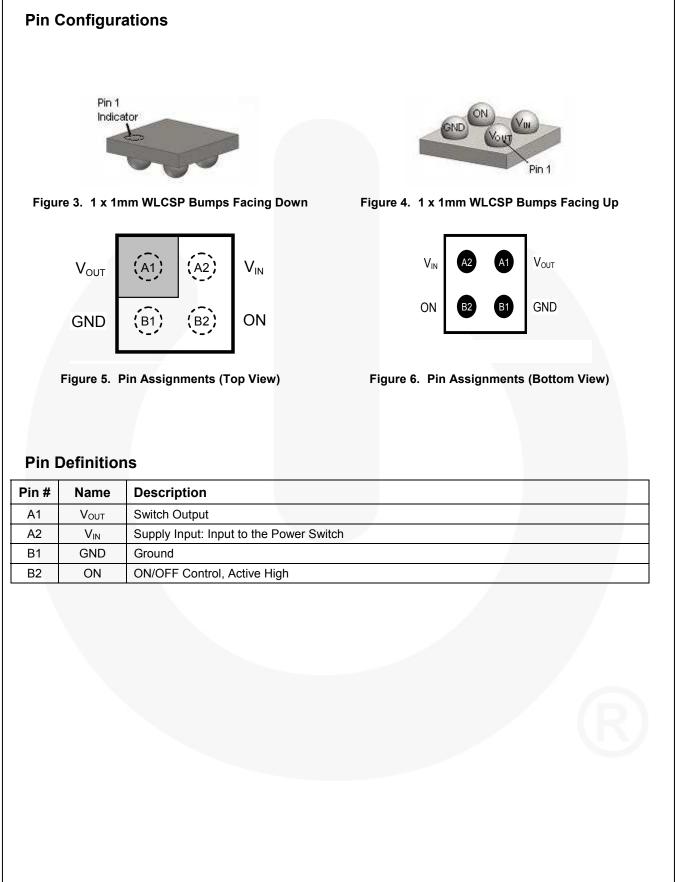
Ø For Fairchild's definition of Eco Status, please visit: <u>http://www.fairchildsemi.com/company/green/rohs\_green.html</u>.

# Typical RDS(ON): 35mΩ at V<sub>IN</sub>=3.3V

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### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Paramet	Min.	Max.	Unit	
V <sub>IN</sub>	V <sub>IN</sub> , V <sub>OUT</sub> , V <sub>ON</sub> to GND		-0.3	4.2	V
I <sub>SW</sub>	Maximum Continuous Switch Current			1.2	А
PD	Power Dissipation at T <sub>A</sub> =25°C			1.0	W
T <sub>STG</sub>	Storage Junction Temperature		-65	+150	°C
TA	Operating Temperature Range		-40	+85	°C
	Thermal Desistance, Junction to Ambient	1S2P with 1 Thermal Via		95	°C/W
$\Theta_{JA}$	Thermal Resistance, Junction-to-Ambient	1S2P without Thermal Via		187	C/W
	Electrostatia Discharge Carability	Human Body Model, JESD22-A114	4		- kV
ESD	Electrostatic Discharge Capability	Charged Device Model, JESD22-C101	2		

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V <sub>IN</sub>	Supply Voltage	1.2	4.0	V
TA	Ambient Operating Temperature	-40	+85	°C

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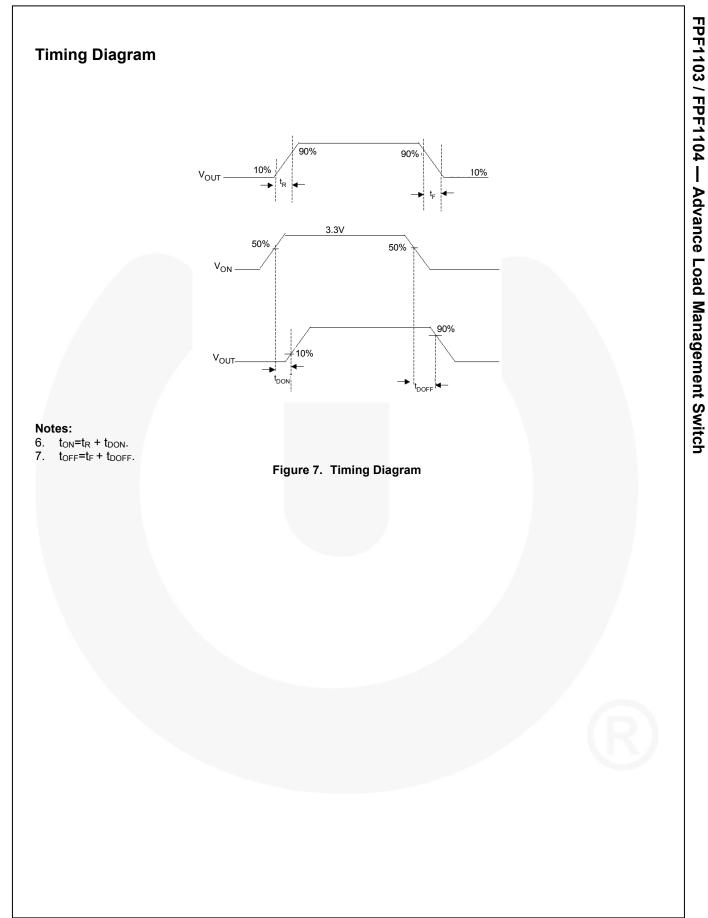
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units	
Basic Ope	ration	l					
V <sub>IN</sub>	Supply Voltage		1.2		4.0	V	
I <sub>Q(OFF)</sub>	Off Supply Current	V <sub>ON</sub> =GND, V <sub>OUT</sub> =Open, V <sub>IN</sub> =4V			1	μA	
I <sub>SD(OFF)</sub>	Off Switch Current	V <sub>ON</sub> =GND, V <sub>OUT</sub> =GND			1	μA	
		I <sub>OUT</sub> =0mA, V <sub>ON</sub> =V <sub>IN</sub>			1		
Ι <sub>Q</sub>	Quiescent Current	I <sub>OUT</sub> =0mA, V <sub>ON</sub> < V <sub>IN</sub>	3			μA	
		V <sub>IN</sub> =3.3V, I <sub>OUT</sub> =200mA, T <sub>A</sub> =25°C		35	50	_	
		V <sub>IN</sub> =1.8V, I <sub>OUT</sub> =200mA, T <sub>A</sub> =25°C		55	70		
Ron	On-Resistance	V <sub>IN</sub> =1.5V, I <sub>OUT</sub> =200mA, T <sub>A</sub> =25°C		70		mΩ	
		V <sub>IN</sub> =1.2V, I <sub>OUT</sub> =200mA, T <sub>A</sub> =25°C		85	150	1	
		V <sub>IN</sub> =1.8V, I <sub>OUT</sub> =200mA, T <sub>A</sub> =85°C <sup>(3)</sup>		65	100		
R <sub>PD</sub>	Output Discharge RPULL DOWN	V <sub>IN</sub> =3.3V, V <sub>ON</sub> =0V, I <sub>FORCE</sub> =20mA, T <sub>A</sub> =25°C, FPF1104		65	110	Ω	
VIH	ON Input Logic High Voltage	V <sub>IN</sub> =1.2V to 4.0V	1.1			V	
VIL	ON Input Logic Low Voltage	V <sub>IN</sub> =1.2V to 4.0V			0.35	V	
I <sub>ON</sub>	ON Input Leakage	V <sub>ON</sub> =V <sub>IN</sub> or GND	-1		1	μA	
Dynamic C	haracteristics		1				
t <sub>DON</sub>	Turn-On Delay <sup>(4)</sup>			35		μs	
t <sub>R</sub>	V <sub>OUT</sub> Rise Time <sup>(4)</sup>	V <sub>IN</sub> =3.3V, R <sub>L</sub> =10Ω, C <sub>L</sub> =0.1μF, T <sub>A</sub> =25°C		65		μs	
t <sub>ON</sub>	Turn-On Time <sup>(4,6)</sup>	T <sub>A</sub> -25 C		100		μs	
t <sub>DON</sub>	Turn-On Delay <sup>(4)</sup>			30	50	μs	
t <sub>R</sub>	V <sub>OUT</sub> Rise Time <sup>(4)</sup>	V <sub>IN</sub> =3.3V, R <sub>L</sub> =500Ω, C <sub>L</sub> =0.1µF,		40	55	μs	
t <sub>ON</sub>	Turn-On Time <sup>(4,6)</sup>	T <sub>A</sub> =25°C		70	105	μs	
PF1103							
tDOFF	Turn-Off Delay <sup>(4)</sup>			2.0	2.5	μs	
t⊨	V <sub>OUT</sub> Fall Time <sup>(4)</sup>	V <sub>IN</sub> =3.3V, R <sub>L</sub> =10Ω, C <sub>L</sub> =0.1µF,		2.2		μs	
toff	Turn-Off <sup>(4,7)</sup>	- T <sub>A</sub> =25°C		4.2		μs	
t <sub>DOFF</sub>	Turn-Off Delay <sup>(4)</sup>			7.0		μs	
t⊨	V <sub>OUT</sub> Fall Time <sup>(4)</sup>	V <sub>IN</sub> =3.3V, R <sub>L</sub> =500Ω, C <sub>L</sub> =0.1µF,		110	y a	μs	
t <sub>OFF</sub>	Turn-Off <sup>(4,7)</sup>	T <sub>A</sub> =25°C		117		μs	
FPF1104 <sup>(5)</sup>		L	1				
t <sub>DOFF</sub>	Turn-Off Delay <sup>(4)</sup>			2.0	2.5	μs	
t <sub>F</sub>	V <sub>OUT</sub> Fall Time <sup>(4)</sup>	$V_{IN}$ =3.3V, R <sub>L</sub> =10Ω, C <sub>L</sub> =0.1µF,		1.9		μs	
toFF	Turn-Off <sup>(4,7)</sup>	R <sub>PD</sub> =65Ω, T <sub>A</sub> =25°C		3.9		μs	
t <sub>DOFF</sub>	Turn-Off Delay <sup>(4)</sup>			2.5		μs	
t <sub>F</sub>	V <sub>OUT</sub> Fall Time <sup>(4)</sup>	$V_{IN}$ =3.3V, R <sub>L</sub> =500 $\Omega$ , C <sub>L</sub> =0.1 $\mu$ F,		10.6		μs	
t <sub>OFF</sub>	Turn-Off <sup>(4,7)</sup>	$R_{PD}=65\Omega, T_{A}=25^{\circ}C$		13.1		μs	

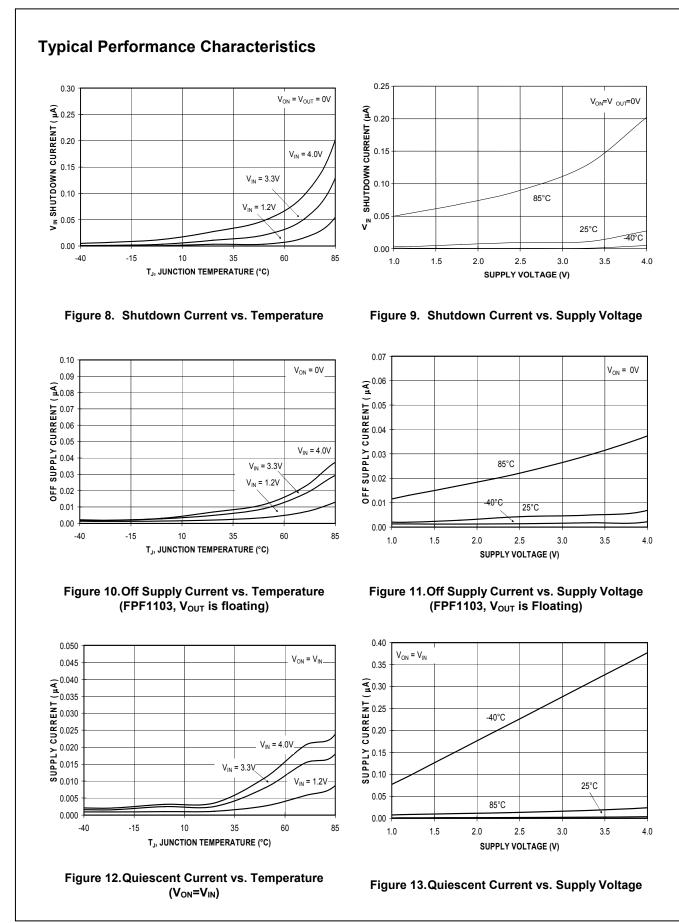
#### Notes:

This parameter is guaranteed by design and characterization; not production tested.  $t_{DON}/t_{DOFF}/t_R/t_F$  are defined in Figure 7. Output discharge path is enabled during off. 3.

4.

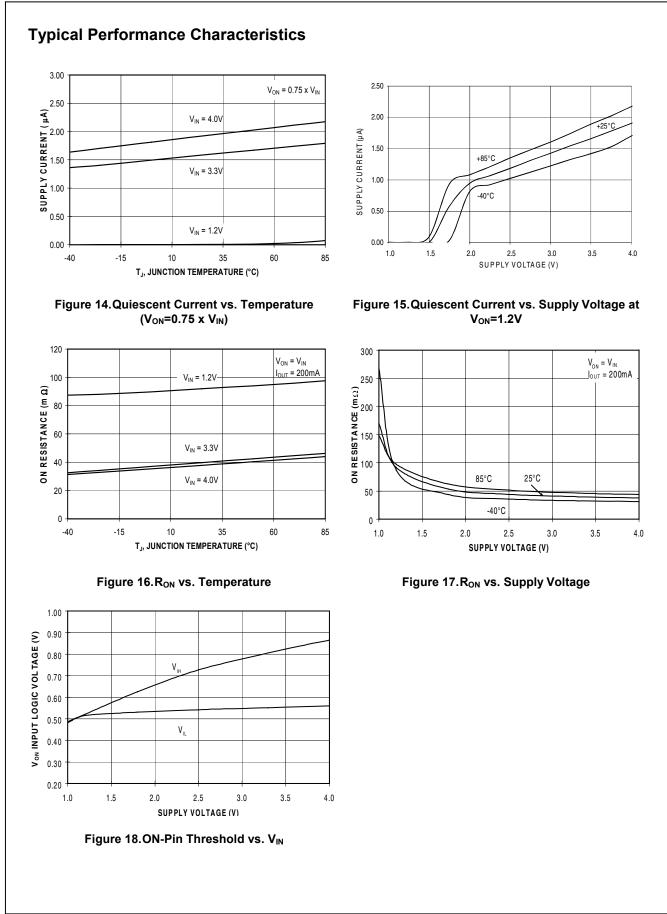
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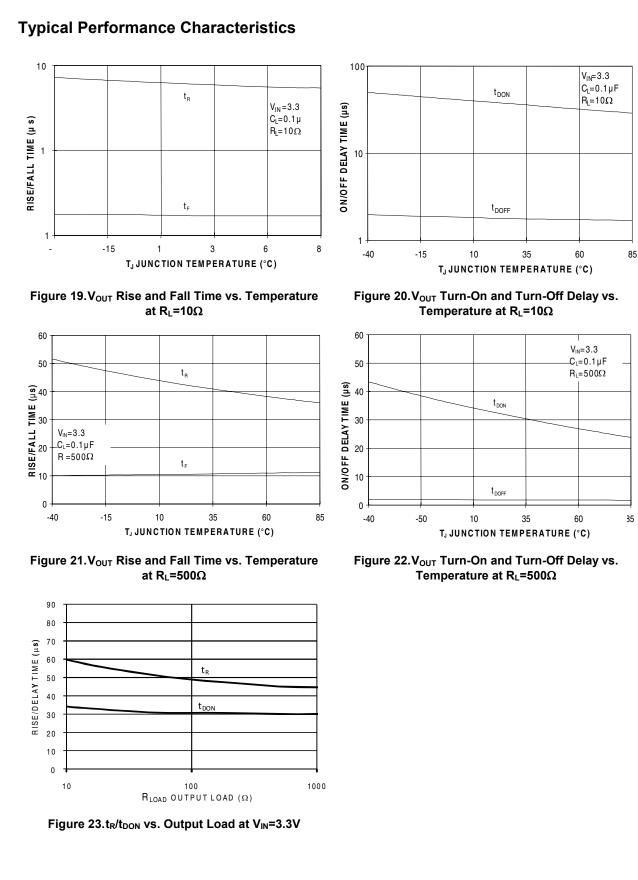




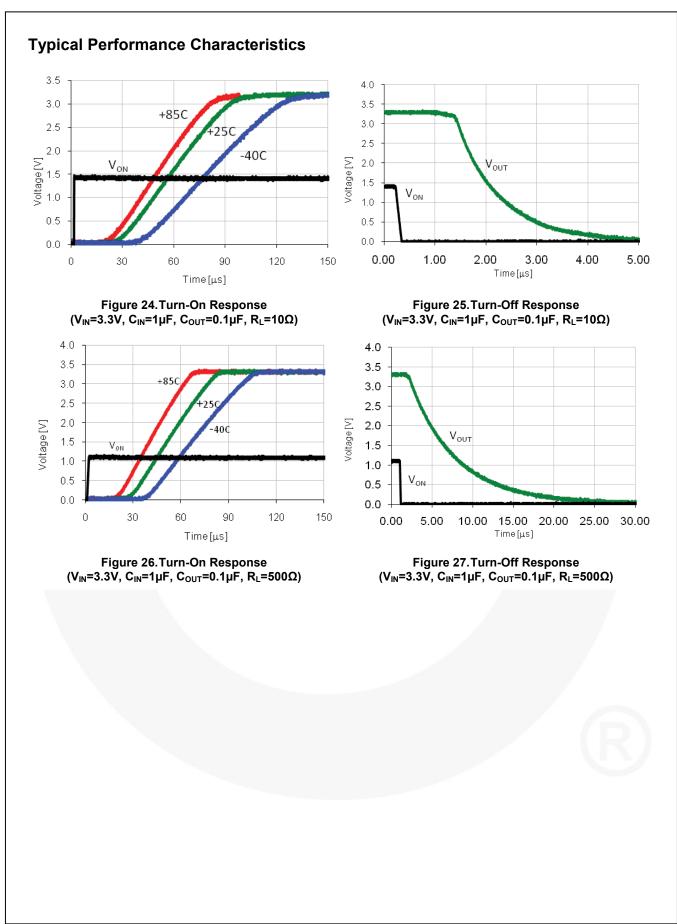
FPF1103 / FPF1104 ---

**Advance Load Management Switch** 





FPF1103 / FPF1104 — Advance Load Management Switch



FPF1103 / FPF1104 — Advance Load Management Switch

### **Application Information**

#### **Input Capacitor**

An IntelliMAX<sup>TM</sup> switch doesn't require an input capacitor. To reduce device inrush current effect, a  $0.1\mu$ F ceramic capacitor, C<sub>IN</sub>, is recommended close to the VIN pin. A higher value of C<sub>IN</sub> can be used to further reduce the voltage drop experienced as the switch is turned on into a large capacitive load.

#### **Output Capacitor**

An IntelliMAX<sup>TM</sup> switch works without an output capacitor. However, if parasitic board inductance forces  $V_{OUT}$  below GND when switching off, a 0.1µF capacitor,  $C_{OUT}$ , should be placed between  $V_{OUT}$  and GND.

#### Fall Time

Device output fall time can be calculated based on RC constant of the external components as follows:

$$t_{\rm F} = R_{\rm L} \times C_{\rm L} \times 2.2 \tag{1}$$

where  $t_F$  is 90% to 10% fall time,  $R_L$  is output load, and  $C_L$  is output capacitor.

The same equation works for a device with a pull-down output resistor.  $R_L$  is replaced by a parallel connected pull-down and an external output resistor combination, as follows:

$$t_{\rm F} = \frac{R_{\rm L} \times R_{\rm PD}}{R_{\rm L} + R_{\rm PD}} \times C_{\rm L} \times 2.2 \tag{2}$$

where  $t_F$  is 90% to 10% fall time,  $R_L$  is output load,  $R_{\text{PD}}\text{=}65\Omega.\text{is}$  output pull-down resistor, and  $C_L$  is the output capacitor.

#### **Resistive Output Load**

If resistive output load is missing, the IntelliMAX<sup>TM</sup> switch without a pull-down output resistor is not discharging the output voltage. Output voltage drop depends, in that case, mainly on external device leaks.

#### **Recommended Land Pattern and Layout**

For best thermal performance and minimal inductance and parasitic effects, it is recommended to keep input and output traces short and capacitors

as close to the device as possible. Below is a recommended layout for this device to achieve optimum performance.

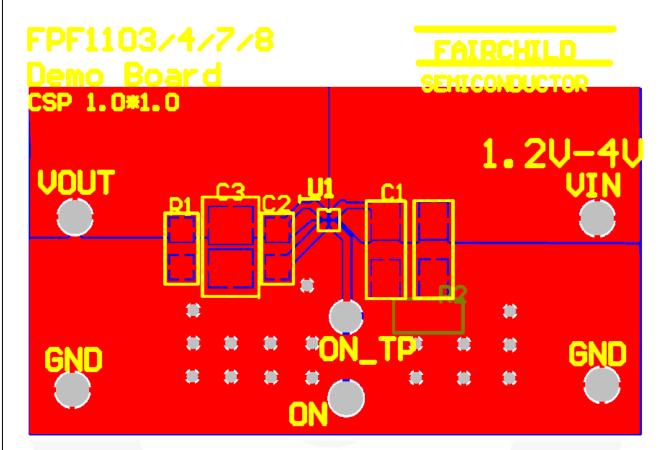
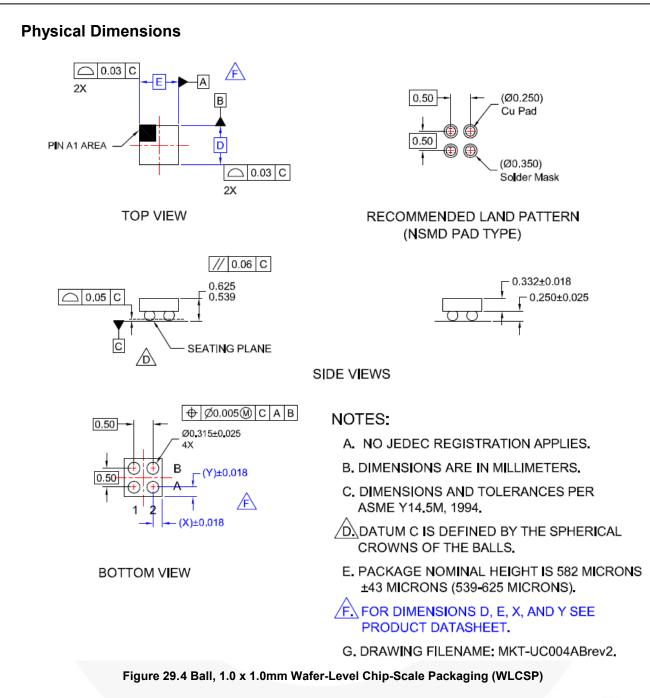


Figure 28. Recommended Land Pattern and Layout

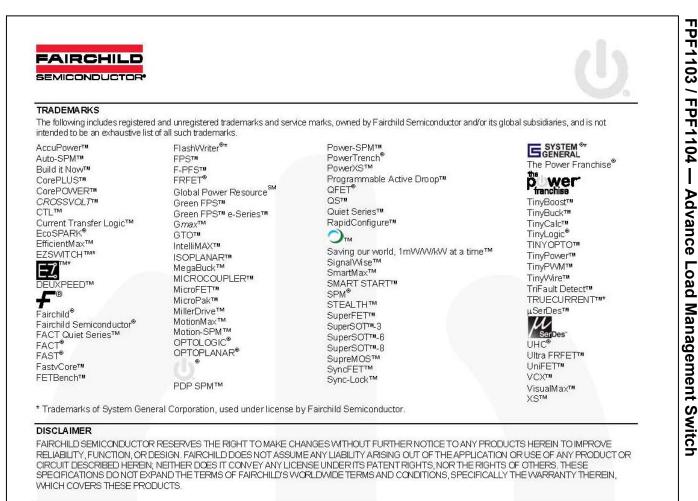


#### **Product-Specific Dimensions**

Product	D	E	x	Y
FPF1103	960µm ± 30µm	960µm ± 30µm	0.230mm	0.230mm
FPF1104	960um ± 30µm	960um ± 30µm	0.230mm	0.230mm

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